

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
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EPAS ID: PAT5948696

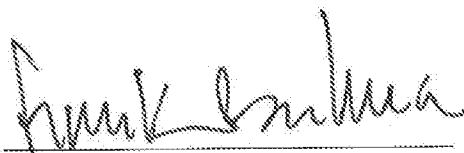
SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
FRANK BALMA	01/13/2020
RECEIVING PARTY DATA	
Name:	COMPONENT RE-ENGINEERING COMPANY, INC.
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15341843
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NAME OF SUBMITTER:	MICHAEL A. GUTH
SIGNATURE:	/Michael A. Guth/
DATE SIGNED:	02/05/2020
Total Attachments: 1	
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ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I, Frank Balma, of Los Gatos, California, hereby sell, assign, and transfer to Component Re-Engineering Company, Inc., a California corporation, having a place of business at 3508 Bassett Street, Santa Clara, CA 95054, its successors and assigns, the entire right, title, and interest throughout the world in my invention in

ELECTROSTATIC CHUCK FOR CLAMPING IN HIGH TEMPERATURE SEMICONDUCTOR PROCESSING AND METHOD OF MAKING SAME

for which I have filed a United States patent application on November 02, 2016, which now has U.S. Patent Application No. 15/341,843, and all national, regional, and international patent applications and patents of every country or region for said invention, including divisions, reissues, continuations, and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, at their request and expense, in obtaining and enforcing patents for said invention in all countries and regions; and I request the United States Patent and Trademark Office to issue all patents granted for said invention to the above-named assignee, its successors, and assigns.



Frank Balma

1-13-2020

Date